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- [(Rev. 10/02)	5-02-	2006	U.S. Patent and Trade	1	
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_ \	Name of conveying party(ies):		2. Name and address of	f receiving party(ies)		
2	Bhaskar V. Nallapureddy	1	2. Maine and address s	, receiving party (166)	0	
	Tsunglun Yu		Name: Marvell Semico	nductor Inc	02 8 ■	
	Yungping Hsu		Traine: Iviai veii eeimee		ω <u>Ω</u>	
	Sek Kin Neng		Internal Address:		jö =	
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	3. Nature of conveyance:		Street Address: 5488 M	larvell I and		
			Officer Address: 5400 iv	arven Lane		
	☐ Security Agreement ☐ Change of	f Name				
			City: Santa Clara	State: <u>CA</u> Zip	o: <u>95054</u>	
	Other					
			Additional Name(s) & ac	ddress(es) attached? 🗌 Y	es ⊠ No	
	Execution Date: 04/24/06; 04/24/06; 04/25/06; 04/2	<u>1/06</u>				
	4 Application number(s) or patent number(s):					
	4. Application number(s) or patent number(s):					
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	Name: Michael D. Wiggins			1) \$ <u>40.00 (via attac</u>	hed credit	
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Washington, D.C. 20231

Docket#: MP0864 PATENT

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Bhaskar V. Nallapureddy

Tsunglan Yu

Yungping Hsu

Sek Kin Neng

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

RADAR DETECTION AND DYNAMIC FREQUENCY SELECTION

Do hereby sell, assign and transfer to Marvell Semiconductor, Inc., a corporation of California, having a place of business at 5488 Marvell Lane, Santa Clara, California 95054, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefore in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions, unions, agreements, acts, and treaties;

Agree that Marvell Semiconductor, Inc., hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

IN TESTIMONY WHEREOF I have hereunto set MY signature on the date indicated below.

Full Name of Sole/First Inventor:		
Bhaskar V. Nallapureddy		
Inventor's Signature:	Date: Month/Day/Year	
may	04/24/06	
Full Name of Second Inventor:		
Tsunglun Yu		
Inventor's Signature:	Date: Month/Day/Year	
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PATENT REEL: 017828 FRAME: 0026

ASSIGNMENT

For good and valuable consideration, the receipt of which is hereby acknowledged, I, the undersigned,

Bhaskar V. Nallapureddy

Tsunglun Yu

Yungping Hsu

Sek Kin Neng

who have created a certain invention for which an application for United States Letters Patent was executed by me concurrently herewith and entitled:

RADAR DETECTION AND DYNAMIC FREQUENCY SELECTION

Do hereby sell, assign and transfer to Marvell Semiconductor, Inc., a corporation of California, having a place of business at 5488 Marvell Lane, Santa Clara, California 95054, its successors, assigns, and legal representatives, the full and exclusive right to said invention and said application and to any and all inventions described in said application for the United States, its territorial possessions and all foreign countries, and the entire right, title and interest in and to any and all Letters Patent which may be granted therefore in the United States, its territorial possessions and all foreign countries; and in and to any and all continuations-in-part, continuations, divisions, substitutes, reissues, extensions thereof, and all other applications for Letters Patent relating thereto which have been or shall be filed in the United States, its territorial possessions and/or any foreign countries, and all rights, together with all priority rights, under any of the international conventions, unions, agreements, acts, and treaties, including all future conventions. unions, agreements, acts, and treaties;

Agree that Marvell Semiconductor, Inc., hereinafter referred to as Assignee, may apply for and receive Letters Patent for said invention and said inventions, hereinafter referred to as said invention, in its own name, in the United States, its territorial possessions, and all foreign countries; and that, when requested to carry out in good faith the intent and purpose of this assignment, at the expense of said Assignee, its successors, assigns and legal representatives, the undersigned will execute all continuations-in-part. continuations, divisions, substitutes, reissues, extensions thereof, execute all rightful oaths, assignments, powers of attorney and other papers, testify in any legal or quasi legal proceedings; communicate to said Assignee, its successors, assigns or legal representatives all facts known to the undersigned relating to said invention and the history thereof; and generally do everything possible which said Assignce, its successors, assigns, or legal representatives shall consider desirable for aiding in securing, maintaining and enforcing proper patent protection for said invention and for vesting title to said invention and all applications for patents on said invention in said Assignee, its successors, assigns, or legal representatives; and

Covenant with said Assignee, its successors, assigns, or legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Full Name of Sole/First Inventor:	
Bhaskar V. Nallapureddy	
Inventor's Signature:	Date: Month/Day/Year
Full Name of Second Inventor:	
Tsunglun Yu	
Inventor's Signature:	Date: Month/Day/Year
	4/24/2006
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Full Name of Third Inventor:				
Yungping Heu				
Inventor's Signature: Juffin Usu	Date: Month/Day/Year 4/ンゴ/06			
Full Name of Fourth Inventor: Sek Kin Neng				
Inventor's Signature:	Date: Month/Day/Year			

2 of 2

PATENT

Full Name of Third Inventor:				
Yungping Hsu				
Inventor's Signature:	Date: Month/Day/Year			
Full Name of Fourth Inventor:				
Sek Kin Neng				
Inventor's Signature:	Date: Month/Day/Year 4/2//06			

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PATENT REEL: 017828 FRAME: 0029